

# SD5210

Intel Gen 10th 10 Cores Xeon, i9 CPU w/ 10 x GbE (Optional 8 x PoE)/ 3 x COM/ 3 x DP/ 4 x USB 3.2 Gen 1x1/ 9-48V Input AI GPU Computing

## Features

- Intel GEN 10th 10 Cores Xeon W-1290TE / i9-10900TE
- 8 x DI, and 4 x DO and 3 x RS-232/422/485
- 1 x M.2 B key, 1 x M.2 A-E key & 3 x MiniPCle expansion slots
- Dual Hot Swappable SATA Storage RAID 0,1,5
- 9-48V DC Input and Operating Temp.: -40~70°C
- 10 x GbE RJ45 (Optional 8 x PoE and 8 x M12 X coded connectors)
- Rolling Stock EN 50155 and EN 50121-3-2 certified



POE



GPS



Wireless



Wide Range



Delay Time

## Introduction

The SD5210 is powered by Intel Gen 10th 10 Cores Xeon W-1290TE / i9-10900TE Fanless Box Computer. It provides high computing performance on graphic processing by harnessing the power of its graphics processing unit (GPU). SD5210 has 8 GPI, 4 GPO DIO ports and 3 RS-232/422/485 serial ports with 10 GbE RJ45 LAN ports (Optional 8 PoE and 8 M12 connectors). It features the Dual Hot Swappable SATA Storage RAID 0, 1, 5, which allows more flexibility for hardware maintenance and expansion.

SD5210 can be adapted to various industrial requirements, including: Smart Solutions, Surveillance Systems, and Visual Management. Furthermore, the environmental tolerance continually maintains a wide range of operating temperatures (-40°C ~ 70°C).

## Specifications

System	
CPU	Intel Gen10 Xeon W-1290TE (20M Cache 2.0GHz up to 4.6GHz)*
	Intel Gen10 Core i9-10900TE (20M Cache 2.0GHz up to 4.5GHz)
	Intel Gen10 Core i7-10700TE (16M Cache 2.0GHz up to 4.4GHz)
	Intel Gen10 Core i5-10500TE (12M Cache 2.3GHz up to 3.7GHz)
	Intel Gen10 Core i3-10100TE (6M Cache 2.3GHz up to 3.6GHz)
	Intel Gen10 Core G5900TE (4M Cache 3.0GHz)
	* Use only with Intel W480E
Chipset	Q470E / W480E
Memory	2 x DDR4 2666/2933 MHz SO-DIMM up to 64GB (Optional ECC support with Xeon W-1290TE)
LAN Chipset	9 x Intel i210-AT and 1 x i219LM (iAMT9.5 w/ i5, i7 only) Gb/s Ethernet Controllers Onboard Support PXE and WOL
Watchdog	1 ~ 255 Level Reset
TPM	2.0
I/O	
Serial Port	3 x RS 232/422/485 (option additional 1 x RS 232/422/485)
USB Port	4 x USB 3.2 Gen 1x1 Ports
LAN	10 x RJ45 Ports for GbE (Optional 8 with M12 X coded connectors and 8 x PoE total Max.120W)
Video Port	3 x DP (Intel built-in GPU)
DIO Port	8 x DI (5~48VDC) and 4 x DO (5VDC, 100mA)
Audio	1 x Line-out, 1 x Line-in and 1 x Mic-in
Expansion Bus	2 x Full Mini-PCle Slots and 1 x Full Mini-PCle Slot w/ USB interface only for WWAN sharing 2 x SIM Card Sockets with M.2 B Key 3042 slot
	1x M.2 A-E Key 2230 slot, 1 x M.2 B Key 3042 slot w/ 2 x SIM Card Sockets for WWAN

Storage	
Type	2 x 2.5" Drive Bay for SATA Type HDD/SSD RAID 0, 1, 5 1 x M.2 M key 2280 slot supports NVMe and SATA SSD *thermal heatsink is required for M.2 storage. Please contact sales window for more information.
Graphics	
CPU Built-in Graphics	Intel® UHD Graphics 630 for z9/i9/i7/i5/i3, Intel® UHD Graphics 610 for G5900TE Max Resolution (DP1.2) : 4096x2304@60Hz
Environmental	
Operating Temp.	-40°C ~ 70°C w/0.6 m/S airflow
Storage Temp.	-40°C ~ 80°C
Relative Humidity	10% RH – 90% RH (non-condensing)
Vibration (with SSD)	IEC60068-2-64, random, 2.5G@5~500Hz, 1hr/axis MIL-STD-810G, Method 514.6, Procedure I, Cat.4, Operating
Shock	Operating: MIL-STD-810G, Method 516.6, Procedure I, Trucks and semi-trailers=15G (11ms) with SSD
Certifications	CE, FCC Class A, E13, EN50155
Power Requirement	
Power Input	9V - 48V DC Power Input
Power Protection	Automatics Recovery Short Circuit Protection
Power Mgmt.	Vehicle Power Ignition for Variety Vehicle
Power Off Control	Power off Delay Time Setting by BIOS and Software
Battery Backup (Option)	Internal Battery Kit for 10 Mins Operating ( Operating Temp. -20 ~ 60°C) *UPS backup time varies depending on actual overall system power consumption.

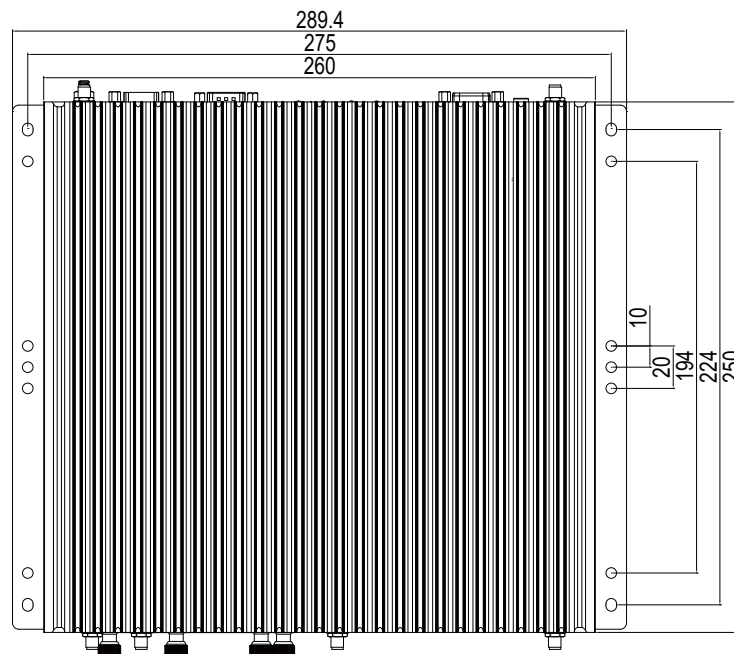
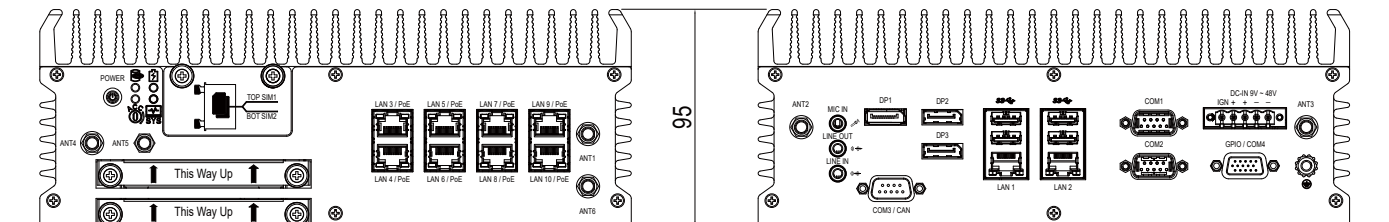
## Specifications

### Mechanical

Construction	Aluminum Alloy
Mounting	Wall-mount
Weight	5300g (Barebone)
Dimensions	260(L) x 250(W) x 95(H) mm

## Dimensions

Unit : mm



## Ordering Information

Part Number	SD5210x-yy (x= P= w/PoE, x= Empty= w/o PoE, yy=Z9= W-1290TE, yy= i9= i9-10900TE, yy= i7= i7-10700TE, yy= i5= i5-10500TE, yy= i3= i3-10100TE, yy= C1= G5900TE)
Description	Intel Gen 10th 10 Cores Xeon, i9 CPU w/ 10 x GbE (Optional 8 x PoE)/3 x COM/ 3 x DP/4 x USB 3.2 Gen 1x1
State of Origin	Made in China

## Optional Accessories

DRAM	DDR4-2933 MHz SO-DIMM, 4GB~32GB, 0~70°C/-40~85°C
SSD	M.2 2280 B-M key NVMe TLC -40~85°C 64GB~1TB w/ Heatsink
	M.2 2280 B-M key SATA TLC -40~85°C 64GB~1TB w/ Heatsink
Wifi	2.5 inch SATA TLC -40~85°C 64GB~2TB
	M.2 2230 A-E key 802.3 a/b/g/n/ac
Modem	M.2 3042 B key 5G&LTE module
GPS	MiniPCIe GPS module
CANBUS	MiniPCIe CANBUS module
Battery backup kit	Battery Kit, 5200m/h, -30~60°C, discharge -20~60°C, operating about 10 mins
Power adaptor	AC/DC 220W/24V or 280W/24V power adaptor